



Special Issue on Information Technology and Applications

Call for Papers

Information Technology and Applications focuses on the design, development, and use of computing systems to solve practical problems across industries and society. It covers areas such as software engineering, databases, networking, artificial intelligence, cybersecurity, and cloud computing. The discipline emphasizes applying technological tools and systems to improve efficiency, decision-making, communication, and innovation in fields including business, healthcare, education, and government.

In this special issue, we intend to invite front-line researchers and authors to submit original research and review articles on **Information Technology and Applications**. Potential topics include, but are not limited to:

- Data science and big data analytics
- Computer networks
- Artificial intelligence and machine learning
- Information systems management
- Human-computer interaction
- Software engineering and development
- Database systems and data management
- Cloud computing & distributed systems
- Virtual reality (VR) and augmented reality (AR)
- Internet of things (IoT) and embedded systems
- Cybersecurity & information assurance
- Networking and communication
- Mobile computing and applications
- Intelligent and decision support systems
- GIS and spatial data analysis
- Robotics and automation systems
- Blockchain & decentralized technologies
- Health informatics and digital health
- Enterprise systems and business process management

Authors should read over the journal's [For Authors](#) carefully before submission. Prospective authors should submit an electronic copy of their complete manuscript through the journal's [Paper Submission System](#).



Please kindly notice that the “**Special Issue**” under your manuscript title is supposed to be specified and the research field “**Special Issue – Information Technology and Applications**” should be chosen during your submission.

According to the following timetable:

Submission Deadline	March 6th, 2026
Publication Date	May 2026

For publishing inquiries, please feel free to contact the Editorial Assistant at submission.entrance1@scirp.org

JCC Editorial Office